# LNJ451C44RA

## Hight Bright Surface Mounting Chip LED

J Type

### ■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter	Symbol	Rating	Unit	
Power dissipation	$P_{\mathrm{D}}$	50	mW	
Forward current	$I_{\mathrm{F}}$	20	mA	
Pulse forward current *	$I_{FP}$	60	mA	
Reverse voltage	V <sub>R</sub>	4	V	
Operating ambient temperature	T <sub>opr</sub>	-25 to +80	°C	
Storage temperature	T <sub>stg</sub>	-30 to +85	°C	

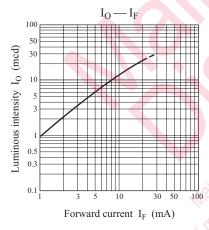
Note) \*: The condition of  $I_{FP}$  is duty 10%, Pulse width 1 msec.

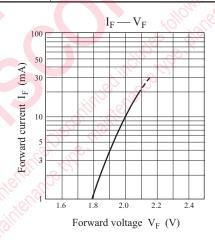
#### ■ Lighting Color

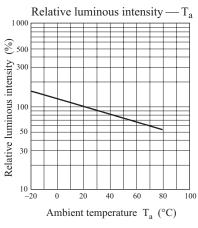
Amber

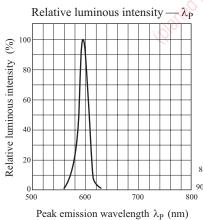
### ■ Electro-Optical Characteristics $T_a = 25$ °C

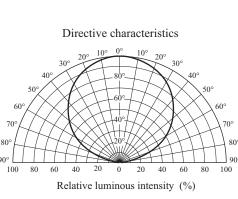
						O	
Parameter	Symbol		Conditions	Min	Тур	Max	Unit
Luminous intensity	I <sub>O</sub>	$I_F = 10 \text{ mA}$		6.9	14.5	5	mcd
Reverse current	$I_R$	$V_R = 4 V$		,,,ct	7160,	100	μΑ
Forward voltage	V <sub>F</sub>	$I_F = 10 \text{ mA}$		(00, 60	2.0	2.3	V
Peak emission wavelength	$\lambda_{ m P}$	$I_F = 10 \text{ mA}$	ion,	dillo	595		nm
Spectral half band width	Δλ	$I_F = 10 \text{ mA}$	Peir Oni	30,	15		nm

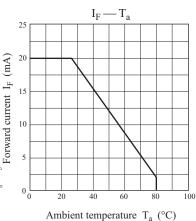








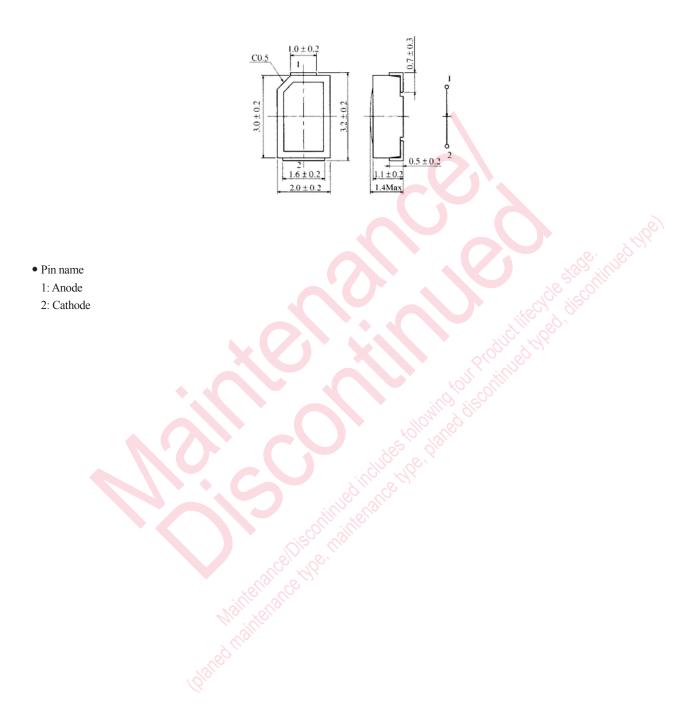




LNJ451C44RA Panasonic

■ Package (Unit: mm)

## LLDFTR2G5100



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